

# TIP29, A, B, C (NPN), TIP30, A, B, C (PNP)

## Complementary Silicon Plastic Power Transistors

... designed for use in general purpose amplifier and switching applications. Compact TO-220 AB package.

### MAXIMUM RATINGS

Rating	Symbol	TIP29 TIP30	TIP29A TIP30A	TIP29B TIP30B	TIP29C TIP30C	Unit
Collector-Emitter Voltage	$V_{CEO}$	40	60	80	100	Vdc
Collector-Base Voltage	$V_{CB}$	40	60	80	100	Vdc
Emitter-Base Voltage	$V_{EB}$	5.0				Vdc
Collector Current Continuous Peak	$I_C$	1.0 3.0				Adc
Base Current	$I_B$	0.4				Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	30 0.24				Watts $W/^\circ\text{C}$
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	2.0 0.016				Watts $W/^\circ\text{C}$
Unclamped Inductive Load Energy (Note 1)	E	32				mJ
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +150				$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	4.167	$^\circ\text{C/W}$

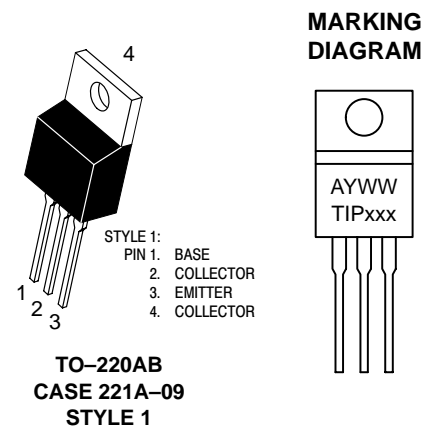
1. This rating based on testing with  $L_C = 20$  mH,  $R_{BE} = 100$   $\Omega$ ,  $V_{CC} = 10$  V,  $I_C = 1.8$  A, P.R.F = 10 Hz.



**ON Semiconductor®**

<http://onsemi.com>

**1 AMPERE  
POWER TRANSISTORS  
COMPLEMENTARY SILICON  
40, 60, 80-100 VOLTS  
30 WATTS**



xxx = Specific Device Code:  
29, 29A, 29B, 29C,  
30, 30A, 30B, 30C  
A = Assembly Location  
Y = Year  
WW = Work Week

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## TIP29, A, B, C (NPN), TIP30, A, B, C (PNP)

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector–Emitter Sustaining Voltage ( $I_C = 30\text{ mAdc}$ , $I_B = 0$ ) (Note 2) TIP29, TIP30 TIP29A, TIP30A TIP29B, TIP30B TIP29C, TIP30C	$V_{CEO(sus)}$	40 60 80 100	– – – –	Vdc
Collector Cutoff Current ( $V_{CE} = 30\text{ Vdc}$ , $I_B = 0$ ) ( $V_{CE} = 60\text{ Vdc}$ , $I_B = 0$ ) TIP29, TIP29A, TIP30, TIP30A TIP29B, TIP29C, TIP30B, TIP30C	$I_{CEO}$	– –	0.3 0.3	mAdc
Collector Cutoff Current ( $V_{CE} = 40\text{ Vdc}$ , $V_{EB} = 0$ ) ( $V_{CE} = 60\text{ Vdc}$ , $V_{EB} = 0$ ) ( $V_{CE} = 80\text{ Vdc}$ , $V_{EB} = 0$ ) ( $V_{CE} = 100\text{ Vdc}$ , $V_{EB} = 0$ ) TIP29, TIP30 TIP29A, TIP30A TIP29B, TIP30B TIP29C, TIP30C	$I_{CES}$	– – – –	200 200 200 200	$\mu\text{Adc}$
Emitter Cutoff Current ( $V_{BE} = 5.0\text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	–	1.0	mAdc

### ON CHARACTERISTICS (Note 2)

DC Current Gain ( $I_C = 0.2\text{ Adc}$ , $V_{CE} = 4.0\text{ Vdc}$ ) ( $I_C = 1.0\text{ Adc}$ , $V_{CE} = 4.0\text{ Vdc}$ )	$h_{FE}$	40 15	– 75	–
Collector–Emitter Saturation Voltage ( $I_C = 1.0\text{ Adc}$ , $I_B = 125\text{ mAdc}$ )	$V_{CE(sat)}$	–	0.7	Vdc
Base–Emitter On Voltage ( $I_C = 1.0\text{ Adc}$ , $V_{CE} = 4.0\text{ Vdc}$ )	$V_{BE(on)}$	–	1.3	Vdc

### DYNAMIC CHARACTERISTICS

Current–Gain — Bandwidth Product (Note 3) ( $I_C = 200\text{ mAdc}$ , $V_{CE} = 10\text{ Vdc}$ , $f_{test} = 1.0\text{ MHz}$ )	$f_T$	3.0	–	MHz
Small–Signal Current Gain ( $I_C = 0.2\text{ Adc}$ , $V_{CE} = 10\text{ Vdc}$ , $f = 1.0\text{ kHz}$ )	$h_{fe}$	20	–	–

2. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

3.  $f_T = |h_{fe}| \cdot f_{test}$ .

### ORDERING INFORMATION

Device	Package	Shipping
TIP29	TO–220AB	50 Units/Rail
TIP29A		
TIP29B		
TIP29C		
TIP30		
TIP30A		
TIP30B		
TIP30C		

# TIP29, A, B, C (NPN), TIP30, A, B, C (PNP)

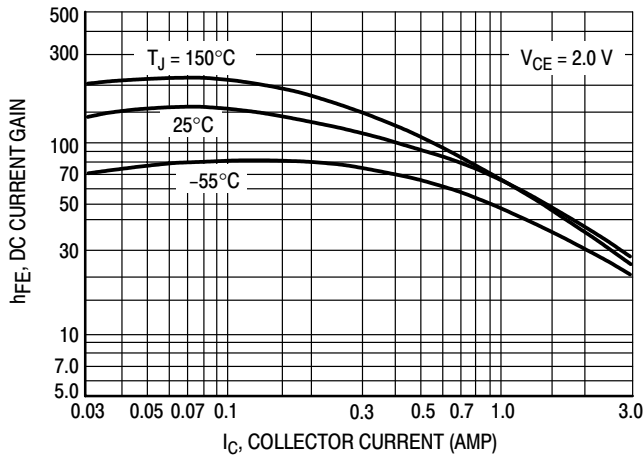


Figure 1. DC Current Gain

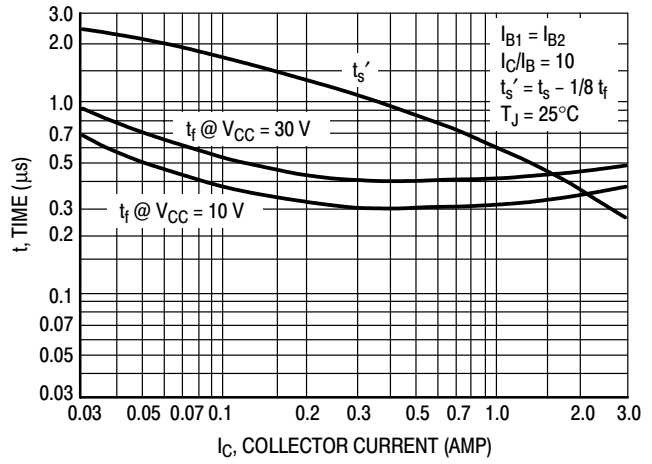


Figure 2. Turn-Off Time

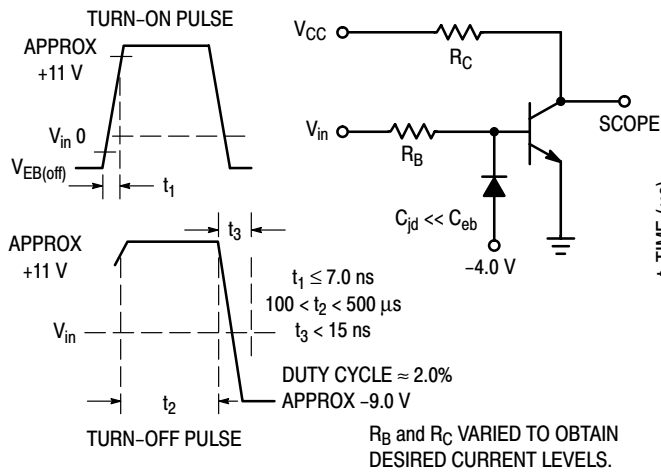


Figure 3. Switching Time Equivalent Circuit

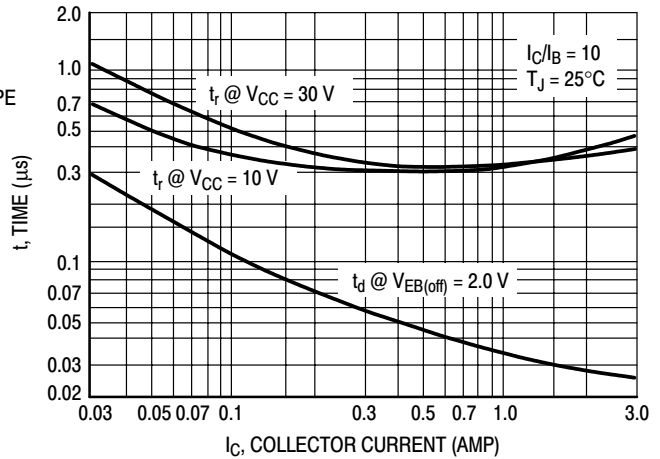


Figure 4. Turn-On Time

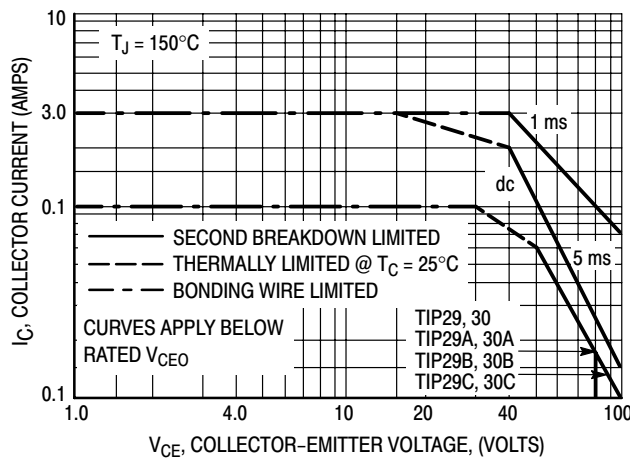


Figure 5. Active Region Safe Operating Area

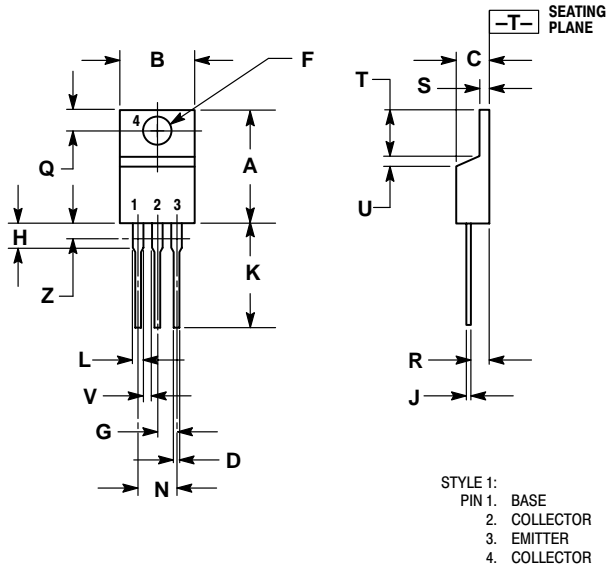
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on  $T_{J(pk)} = 150^\circ\text{C}$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^\circ\text{C}$ . At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

# TIP29, A, B, C (NPN), TIP30, A, B, C (PNP)

## PACKAGE DIMENSIONS


TO-220AB  
CASE 221A-09  
ISSUE AA



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

### PUBLICATION ORDERING INFORMATION

#### Literature Fulfillment:

Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center  
4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031  
Phone: 81-3-5740-2700  
Email: r14525@onsemi.com

ON Semiconductor Website: <http://onsemi.com>

For additional information, please contact your local Sales Representative.